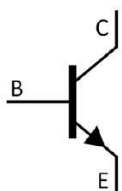


/ Descriptions

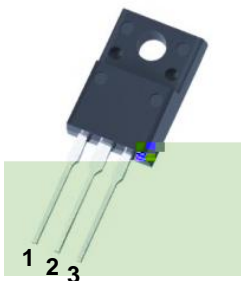
/ Features

/ Applications

/ Equivalent Circuit



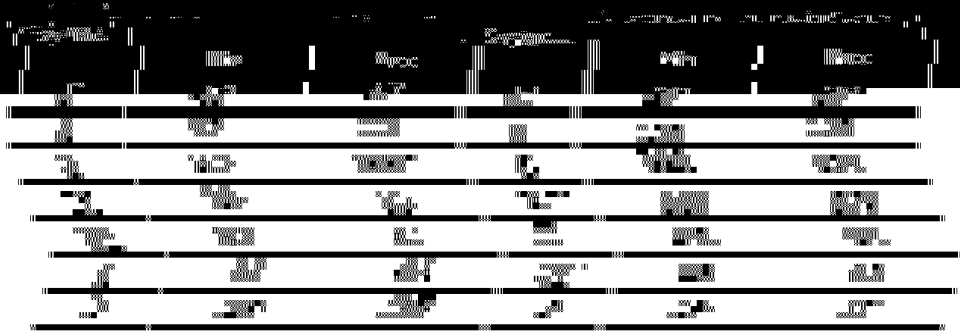
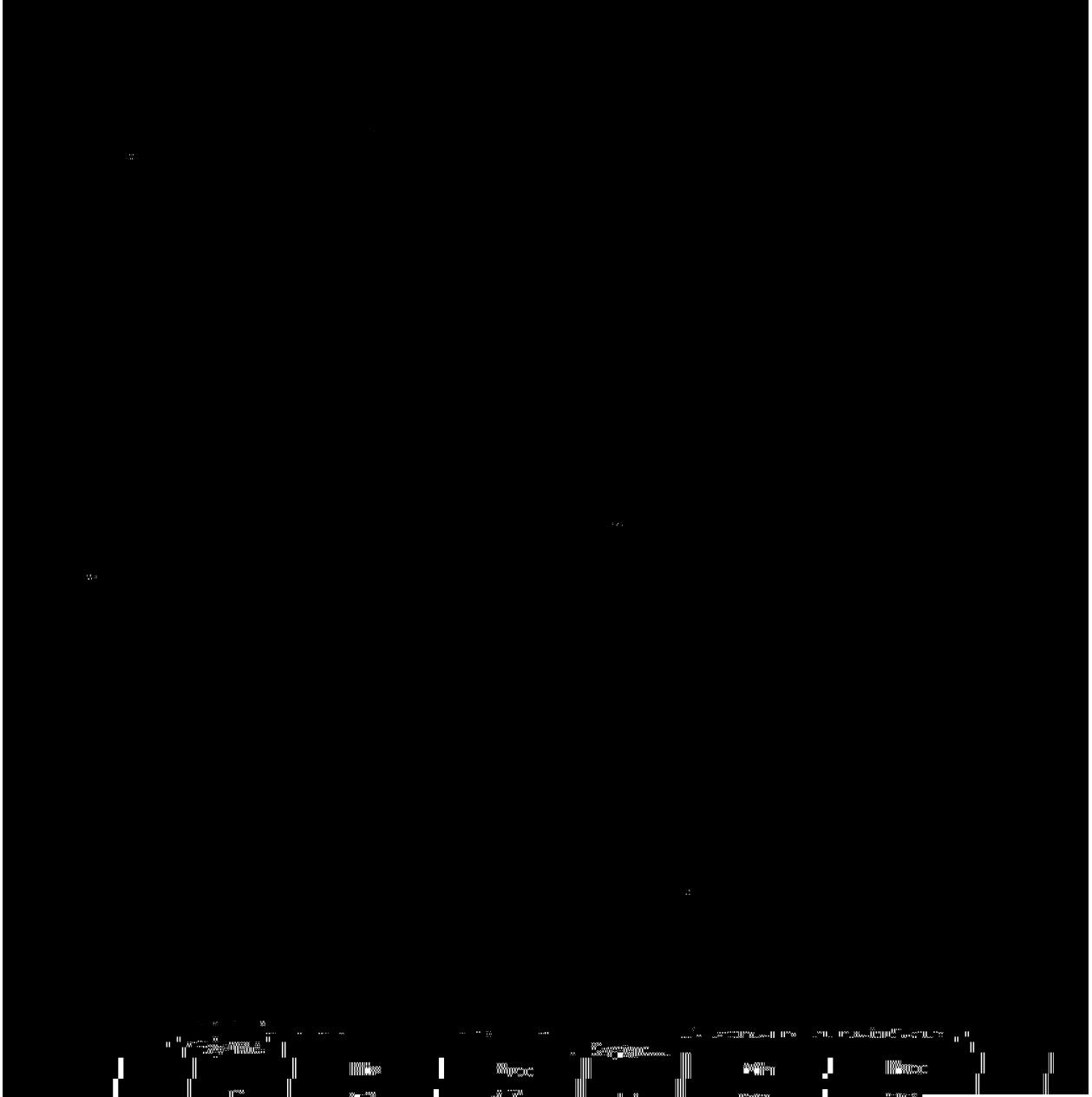
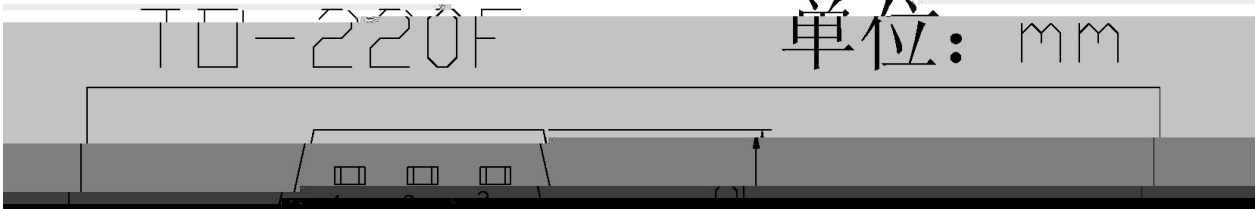
/ Pinning



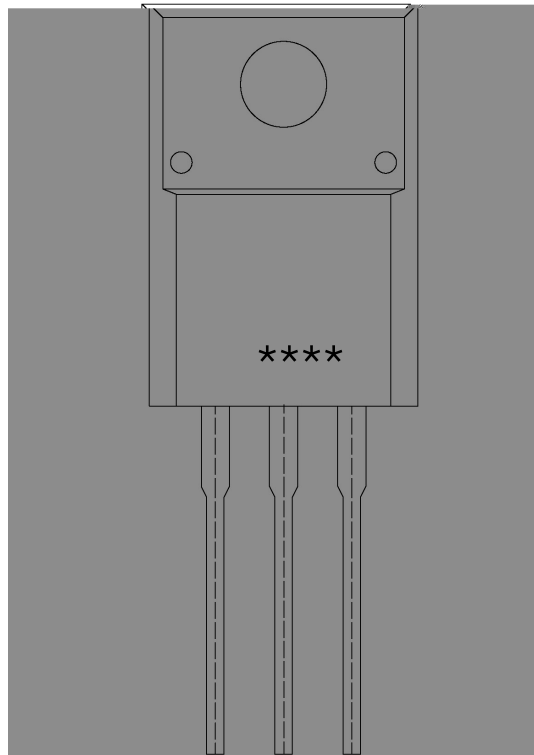
/ h_{FE} Classifications & Marking

						μ

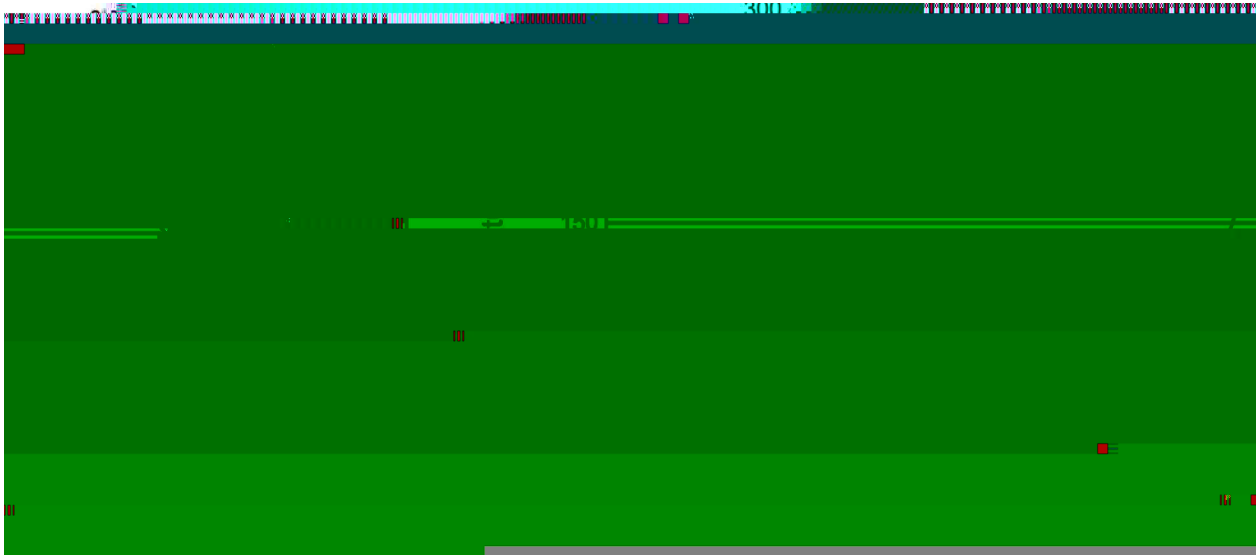
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

	Units/Bag /	Bags/Inner Box /	Units/Inner Box /
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